

### **TYA- Low Profile High Current SMT Power Inductor** FYA252010 Series

## FEATURES AND APPLICATIONS

**Laird TYA series high current power inductors** improve performance, reliability and power efficiency. A lower profile benefits consumer electronics, industrial and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and wire wound construction and perform in operating temperatures ranging from -40 C to 125 C including self-heating rise in temperature.

#### **FEATURES**

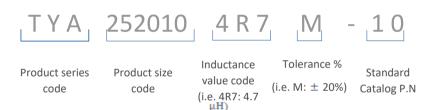
- Magnetic shielded structure
- Low DCR and high efficiency
- Low profile and small size
- Metal alloy core with high saturation

#### **APPLICATIONS**

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments



#### PART NUMBER EXPLANATION



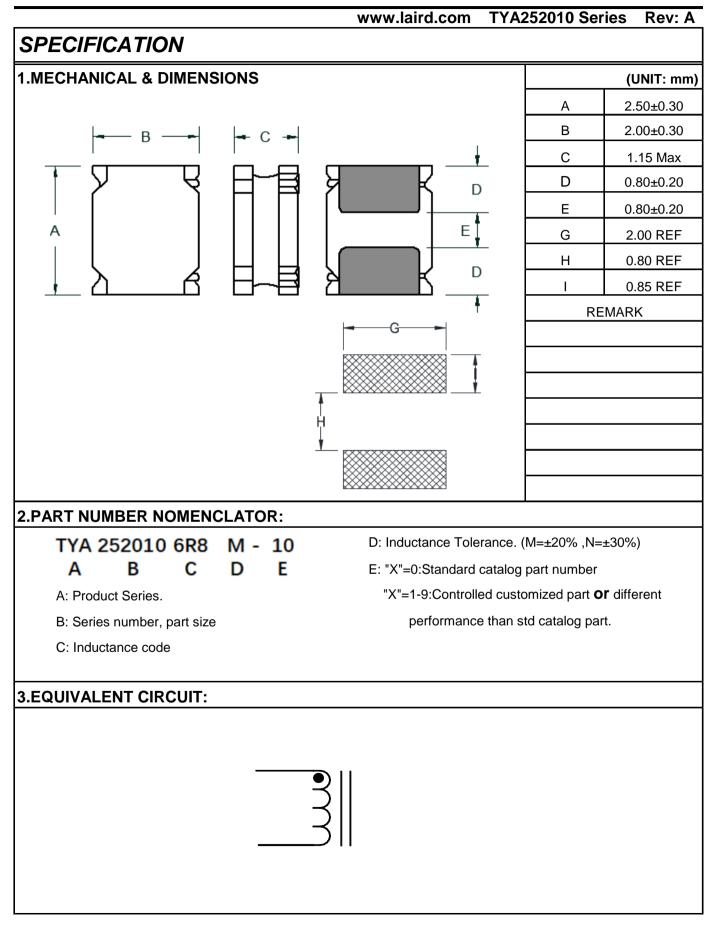
#### **ELECTRICAL SPECIFICATIONS**

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 1MHz, 1.0Vrms
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 70%(MAX.)

Note: Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air.

The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.



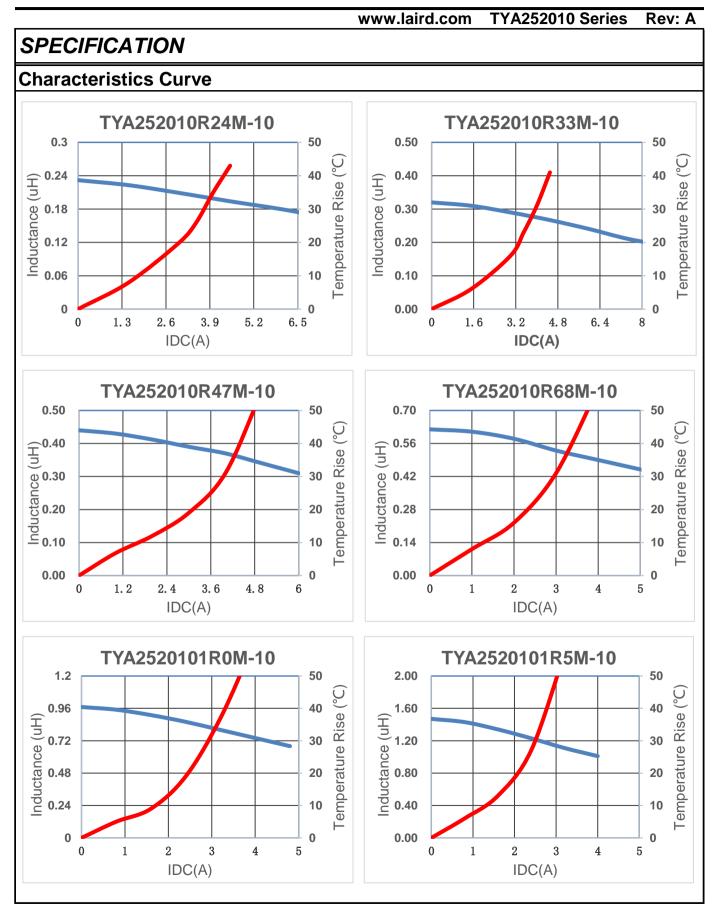




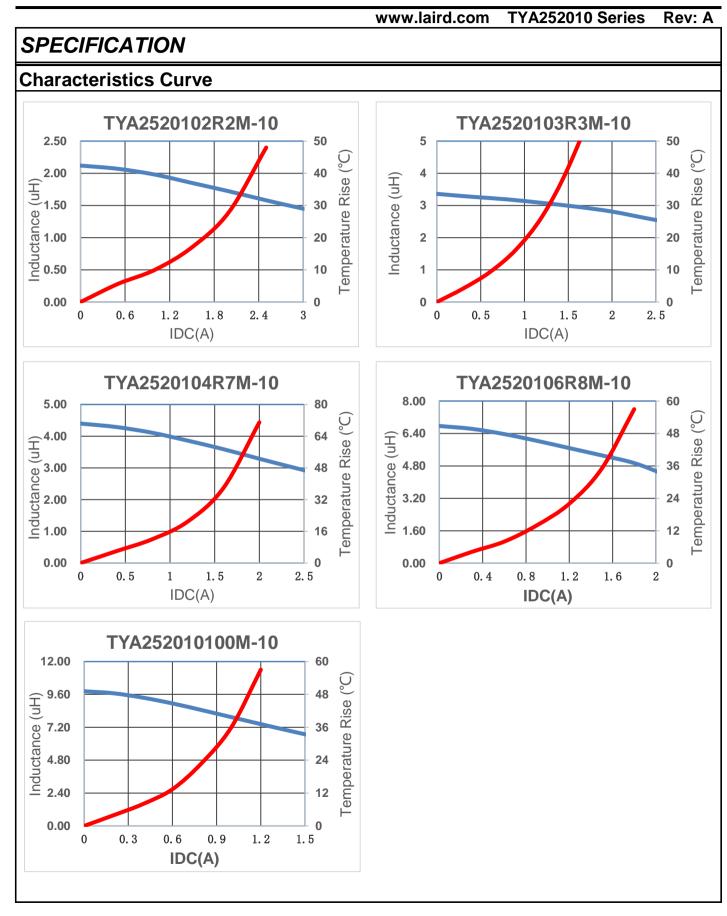
		ww	w.laird.com T	YA252010 Seri	es Rev: A	
SPECIFICATION						
PART NUMBER	INDUCTANCE (uH)	Irms(A) Typ.	Isat(A) Typ.	DCR(mΩ) Max	REMARK	
TYA252010R24M-10	0.24	3.70	6.10	33.0		
TYA252010R33M-10	0.33	3.50	4.80	39.0		
TYA252010R47M-10	0.47	3.20	4.40	45.0		
TYA252010R68M-10	0.68	2.75	3.20	59.0		
TYA2520101R0M-10	1.00	2.20	3.10	85.0		
TYA2520101R5M-10	1.50	2.00	2.60	106.0		
TYA2520102R2M-10	2.20	1.50	1.90	155.0		
TYA2520103R3M-10	3.30	1.20	1.60	235.0		
TYA2520104R7M-10	4.70	1.00	1.30	290.0		
TYA2520106R8M-10	6.80	0.95	1.00	480.0		
TYA252010100M-10	10.00	0.65	0.90	740.0		
GENERAL SPECI	FICATION:					
1, Test conditions(L)	: 1.0MHz, 1Vrms					
2, Operating temperature: -40 $^{\circ}$ C to +125 $^{\circ}$ C (Including self-heating)						
3, Storage temperatu	ure: -10℃ to +40℃	C				
4, Humidity range: 70% RH Max.						
5, Heat Rated Current (Irms) will cause the coil temperature rise approximately $\Delta t$ of 40°C						
6, Saturation Current	t (Isat) will cause L	_0 to drop approxir	nately 30%.			
7, Part Temperature	(Ambient+Temp.	Rise) : Should not	exceed 125°C ur	nder worst case c	onditions.	
8, Storage condition	(component in its	packaging)				

# Laird Steward

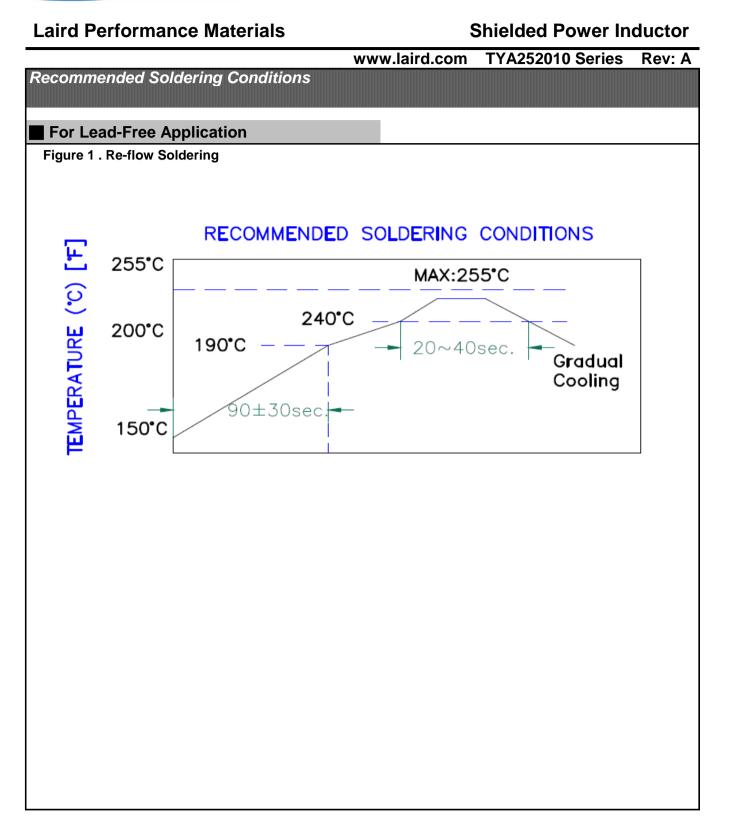
#### Laird Performance Materials







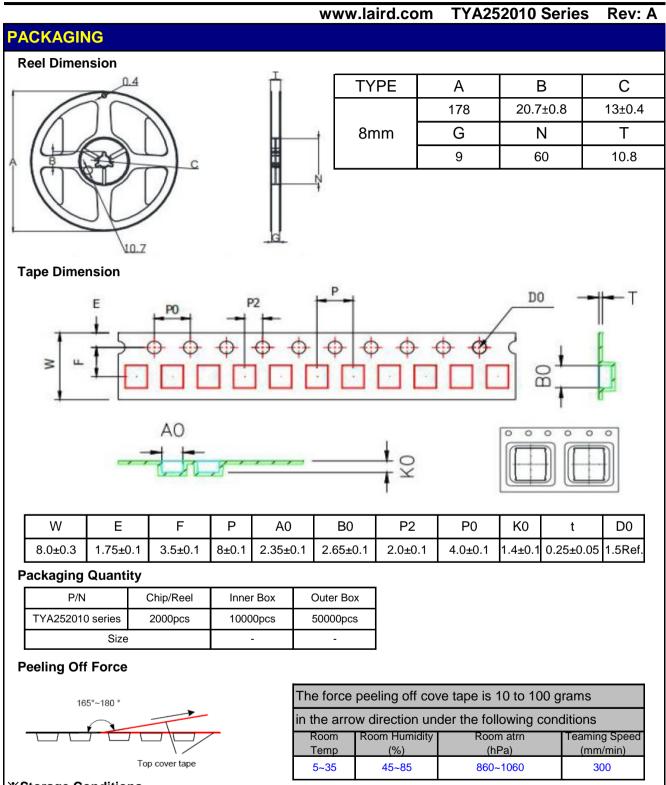






www.laird.com TYA252010 Series Rev: A						
Reliability and Testing Conditions / Pin Type Power Inductors						
SMD series(Consumer)						
ltem	Reference	Additional Requirements				
Operating temperature range	-40°C ~ +125°C (Including self-temperature rise)					
Storage temperature and humidity range	-10 $^\circ \!\! \mathbb{C}$ to +40 $^\circ \!\! \mathbb{C}$ , 70% RH Max					
High Temperature Exposure (Storage)	MIL-STD-202 Method 108	85±2℃, 168+24hours				
Temperature Cycling	JESD22 Method JA-104	-40 °C → +85, transforming interval:20s, 100cycles				
Operational Life	MIL-PRF-2	85±℃, 168+24hours Apply maximum rated voltage and current according part drawing				
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrical Test not required.				
Physical Dimension	JESD22 Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical Test not required				
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)				
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5℃,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu				
Solderability	J-STD-002	245±5℃, 5±1sec, Solder: Sn/3.0Ag/0.5Cu				
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures				
Board Flex	AEC-Q200-005	2mm,30±1s				
Terminal Strength(SMD)	AEC-Q200-006	10N, 5S, X,Y direct				





- **Storage Conditions** 1. Temperature and humidity conditions: -10-+40 $^{\circ}$ C
- and 70% RH.
- 2. Recommended products should be used within 12 months from the time of manufacturing.
- 3. The packaging material should be kept where no chlorine
- or sulfur exists in the air.
- 4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking

# **Mouser Electronics**

Authorized Distributor

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Laird Performance Materials:

<u>TYA2520104R7M-10</u> <u>TYA2520106R8M-10</u> <u>TYA252010R68M-10</u> <u>TYA252010100M-10</u> <u>TYA2520101R0M-10</u> TYA2520101R5M-10 TYA2520102R2M-10 TYA2520103R3M-10